

NOTES:

MATERIAL:

- 1.HOUSING MATERIAL :GLASS FILLED POLYESTER(UL94V-0).
- 2.CONTACT MATERIAL :PHOSPHOR BRONZE $\phi 0.46\text{mm}$ (C5100).
- 3.PLATING :GOLD PLATING OVER NICKEL.
- 4.SHIELD: COPPER ALLOY 0.20mm THICKNESS PLATING NI.

ELECTRICAL:

- 1.VOLTAGE RATING :125 VAC RMS.
- 2.CURRENT RATING :1.5 AMP.
- 3.CONTACT RESISTANCE :50 MILLIOHMS MAX.
- 4.INSULATION RESISTANCE :500 MEGOHMS MIN @ 500V DC.
- 5.DIELECTRIC WITHSTANDING
RESISTANCE :1000V AC RMS 50Hz. 1MIN.

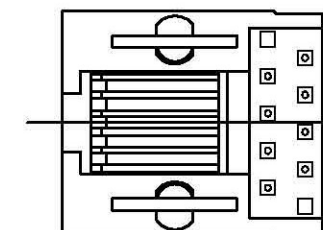
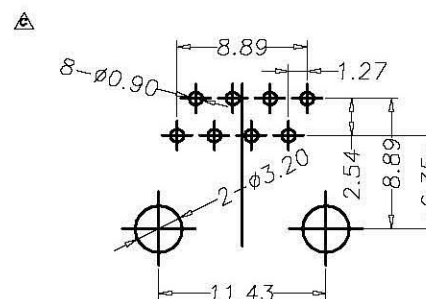
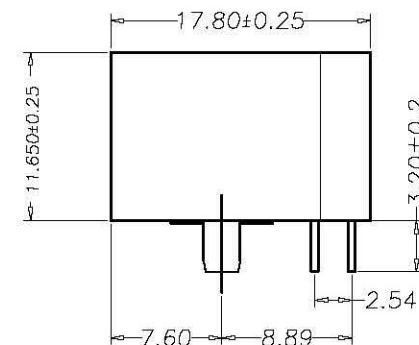
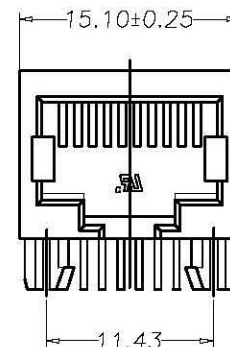
MECHANICAL:

- 1.DURRABILITY :750 CYCLES MIN.
- 2.PCB RETENTION PRE-SOLDER :1 LB MIN.

ENVIRONMENTAL:

- 1.STORAGE : -40°C TO $+85^{\circ}\text{C}$.
2. OPERATION : 0°C TO 70°C .

MATES WITH MODULAR PLUG CONFORMING TO
FCC PART 68,SUBPART F.



DETACHED LISTS	MM (INCH)		设计 zhangwei	日期 13.03.10	深圳市连欣科技有限公司	
	一般公差		审核	日期		
	MM		批准 zhang ke	日期 13.03.10	系列	名称
	.0 ± 0.20	±	材料:		系列	5801B-10P8C
	.00 ± 0.15	±	数量:		图号: RJ-58B-001	版本
	.000 ± 0.075	±	表面处理:		料号: XDRJ-5801B-001	A4 A
角度 ± 0.01°			比例: 1:1		不按比例	共 X 页 第 Y 页
第三角视图						